MULTITRACK CASSETTE RECORDER



SERVICE MANUAL



■ CONTENTS (目次)

SPECIFICATIONS (総合仕様)····································
PANEL LAYOUT (パネルレイアウト) ····································
DIMENSIONS (寸法図) ·······10
CIRCUIT BOARD LAYOUT (ユニットレイアウト) ······11
DISASSEMBLY PROCEDURE (分解手順)······13
LSI PIN DESCRIPTION (LSI端子機能表)······19
IC BLOCK DIAGRAM (ICブロック図)······20
CIRCUIT BOARDS (シート基板図)······22
CASSETTE MECHANISM ADJUSTMENT PROCEDURE
(MECHANICAL)(カセットメカニズム調整手順)·····41/57
GENERAL ADJUSTMENT PROCEDURE FOR MT8X
(ELECTRICAL) (MT8X総合調整手順(電気))·······47/62
REGARDING SPECIAL MODE (TEST PROGRAM)
(特殊モード(テストプログラム))55/70
POT & COIL LAYOUT (調整用ボリューム、コイルレイアウト)…72
PARTS LIST
BLOCK DIAGRAM (ブロックダイアグラム)
CONNECTION(結線図)
OVERALL CIRCUIT DIAGRAM(総回路図)

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IMPORTANT NOTICE

This manual has been provided for the use of authorized Yamaha Retailers and their service personnel. It has been assumed that basic service procedures inherent to the industry, and more specifically Yamaha Products, are already known and understood by the users, and have therefore not been restated.

WARNING:

Failure to follow appropriate service and safety procedures when servicing this product may result in personal injury, destruction of expensive components and failure of the product to perform as specified. For these reasons, we advise all Yamaha product owners that all service required should be performed by an authorized Yamaha Retailer or the appointed service representative.

IMPORTANT: The presentation or sale of this manual to any individual or firm does not constitute authorization, certification, recognition of any applicable technical capabilities, or establish a principle-agent relationship of any form.

The data provided is believed to be accurate and applicable to the unit(s) indicated on the cover. The research, engineering, and service departments of Yamaha are continually striving to improve Yamaha products. Modifications are, therefore, inevitable and changes in specification are subject to change without notice or obligation to retrofit. Should any discrepancy appear to exist, please contact the distributor's Service Division.

WARNING:

Static discharges can destroy expensive components. Discharge any static electricity your body may have accumulated by grounding yourself to the ground buss in the unit (heavy gauge black wires connect to this buss).

IMPORTANT: Turn the unit OFF during disassembly and parts replacement. Recheck all work before you apply power to the unit.

WARNING: CHEMICAL CONTENT NOTICE!

The solder used in the production of this product contains LEAD. In addition, other electrical/ electronic and/or plastic (where applicable) components may also contain traces of chemicals found by the California Health and Welfare Agency (and possibly other entities) to cause cancer and/or birth defects or other reproductive harm.

DO NOT PLACE SOLDER, ELECTRICAL/ELECTRONIC OR PLASTIC COMPONENTS IN YOUR MOUTH FOR ANY REASON WHAT SO EVER!

Avoid prolonged, unprotected contact between solder and your skin! When soldering, do not inhale solder fumes or expose eyes to solder/flux vapor!.

If you come in contact with solder or components located inside the enclosure of this product, wash your hands before handling food.

■ WARNING

Components having special characteristics are marked Δ and must be replaced with parts having specifications equal to those originally installed.

▲印の部品は、安全を維持するために重要な部品です。交換する場合は、安全のため必ず指定の部品をご使用下さい。

■ SPECIFICATIONS

AUX SEND 1, 2

STEREO OUT L, R

MONITOR OUT L, R

TAPE OUT 1 - 8

PHONES

MODEL	8-track/8-channel one way	recording and playback cassette recor	der with mixer
TAPE TRANSPORT	Tape Type	CrO₂ (Bias: HIGH; EQ: 70 μs)	
	Track Configuration	8-track/8-channel one way recording	and playback
*		8-channel Permalloy rec/play head x	
•		8-channel ferrite erase head x 1	•
	· Motor	DC servo motor for capstan x 1	
		DC motor for reel x 1	
		DC motor for mechanism control x 1	(x,y) = (x,y) + (x,y
	Tape Speed	9.5 cm/sec.	
	Pitch Control	Approx. ±12%	
	Wow & Flutter	0.08% WRMS or less	
	Rewind Time	Approx. 95 sec. at normal speed (for	C-60 tape)
		Approx. 75 sec. at high speed (for C-	60 tape)
	AUX SEND x 2 TAPE OUT x 8 CH1 – 8	STEREO OUT L,R x 1 PHONES L,R x 1	MONITOR OUT L, R x 1
CONNECTORS			
MIC/LINE 1 – 4	Input impedance 10 k Ω	Rated Input Level –10	dB to -50 dB (ch. fader nominal)
	Min. Input Level -56 dB (gain	control, ch. fader max.)	
		n control min., headroom margin)	·
INSERT IN 1, 2	Input Impedance 10 k Ω	Rated Input Level –10	dB
	Min. Input Level –16 dB (ch. f	fader max.)	ID () Color or analysis all
LINE 5 – 8	Input Impedance 10 kΩ	•	dB (ch. fader nominal)
	Min. Input Level –16 dB (ch. f	fader max.)	JD (ALLY DTN LEVEL control naming
AUX RETURN L/R 1, 2	Input Impedance 20 kΩ		dB (AUX RTN LEVEL control nomina
	Min. Input Level –16 dB (AU)	(RIN LEVEL control max.)	dB (MONITOD/BHONES control
2TR IN L, R	Input Impedance 10 kΩ	Hated Input Level -10	dB (MONITOR/PHONES control nominal)
	Min. Input Level –16 dB	Rated Load Impedanc	,
INSERT OUT 1, 2	Output Impedance 100 Ω	•	G IO V77 OLIHOLG

Rated Load Impedance 10 $k\Omega$ or more

Max. Output Level 100 mW (at 40 Ω load)

Rated Output Level -10 dB (at $10 \text{ k}\Omega$ load)

Rated Output Level -10 dB (at 10 kΩ load)

Rated Output Level –10 dB (at 10 $k\Omega$ load)

Rated Output Level -10 dB (at $10 \text{ k}\Omega$ load)

Rated Output Level –10 dB (at 10 kΩ load)

Output Impedance 1 k Ω

Output Impedance 1 $k\Omega$

Output Impedance 1 k Ω

Output Impedance 100 Ω

Rated Load Impedance 8–40 Ω

MIXER

Frequency Response (At Rated Input and Output)

MIC IN-STEREO OUT

20 Hz - 20 kHz + dB

LINE IN-STEREO OUT LINE IN-PHONES OUT

Noise level (12.7 kHz: 6 dB/oct. L.P.F)

Signal process noise:

-115 dB/Rs = 150 Ω

STEREO OUT:

-80 dB/CH, optimum position of the Master Fader

S/N Ratio (At Rated Input and Output Levels)

68 dB/IHF-A MIC IN-STEREO OUT (GAIN TRIM MAX.)

70 dB/IHF-A LINE IN-STEREO OUT (GAIN TRIM MIN.)

Distortion (1 kHz, At Rated Input and Output)

0.3 %/30 kHz L.P.F MIC IN-STEREO OUT (GAIN TRIM MAX.) 0.05 %/30 kHz L.P.F LINE IN-STEREO OUT (GAIN TRIM MIN.)

Equalizer

LOW/SHELVING MID/PEAKING

Standard Frequency 100 Hz Standard Frequency 1 kHz

Variable Range ±12 dB Variable Range ±12 dB

HIGH/SHELVING

Standard Frequency 10 kHz

Variable Range ±12 dB

RECORDER

Overall Frequency Response

Overall S/N ratio

Overall Distortion

Overall channel separation

(between adjacent channels)

Erasure Rate

Noise Reduction

(4 track simultaneous recording)

50 Hz -14 kHz +3dB (dbx NR OFF)

80 dB/IHA-F (dbx NR ON), (At distortion level of 3 %)

2 % (400 Hz, -10 dB) 60 dB (1 kHz, -10 dB, dbx NR ON)

55 dB (1 kHz, 0 dB)

dbx NR (SYNC position: TR8 = OFF)

GENERAL

Control Jacks

PUNCH I/O (FC4 or FC5)

REMOTE CONTROL (RCM1)

Power Requirements

U.S. & Canadian Models: 120 V AC, 60 Hz

UK Model: 240 V AC, 50 Hz General Model: 230 V AC, 50 Hz

Power Consumption

40 W

Dimensions (WxHxD)

489 mm X 129 mm X 390 mm (19 -1/4" X 5 - 1/16" X 15 - 3/8")

Weight

7.0 kg (15 lbs. 6 oz.)

Accessory

AC power cord, cotton swab

dbx is a trademark of dbx incorporated. 0 dB = 0.775 Vr.m.s.

■ 総合仕様

形式:

ミキサー付8トラック8チャンネル片道録音/再生カセットレコーダー

機構部:

使用テープ

C-46 ~ 90 カセットテープ CrO2 (TypeII) 専用

トラック形式

8トラック/8チャンネル 片道録音/再生

ヘッド構成

8 チャンネル録音/再生:ハードパーマロイ ×1

8 チャンネル消去:フェライト×1

モーター

DCサーボモーター キャプスタン用×1

DCモーター リール用×1

DCモーター メカニズムコントロール用×1

テープ速度

9.5 cm/sec.

ピッチコントロール 約 ±12%

ワウフラッター

0.08 % W.RMS以下

早巻き時間

約95秒 ノーマル (C-60 テープ)

約75秒 高速 (C-60テープ)

電気部: 0dB=0.775Vrms

《入出力チャンネル数》

 $MIC/LINE \times 4 CH1 \sim 4$

INSERT I/O $\times 2$ CH1 ~ 2

LINE $\times 3$ CH5 ~ 7

LINE L/MONO,R $\times 1$ CH8 AUX RETURN L/MONO,R $\times 2$

2TR IN L,R X1

 $\mathbf{AUX}\ \mathbf{SEND}\ {\times} 2$

STEREO OUT L,R ×1

MONITOR OUT L,R ×1

TAPE OUT $\times 8$ CH1 ~ 8

PHONES L,R X1

仕様:

MIC/LINE 1 ~ 4

入力インピーダンス 10 kΩ

規定入力レベル -10dB ~ -50dB (CH FADER 規定位置)

最小入力レベル -56dB (GAIN TRIM, CH FADER MAX.)

最大入力レベル +10dB (GAIN TRIM MIN.ヘッドルームマージン)

INSERT IN 1.2

入力インピーダンス 10 kΩ

規定入力レベル -10dB

最小入力レベル -16dB (CH FADER MAX.)

LINE 5 ~ 8

入力インピーダンス 10 kΩ

規定入力レベル-10dB (CH FADER 規定位置)

最小入力レベル -16dB (CH FADER MAX.)

AUX RETURN L/R 1,2入力インピーダンス 20 kΩ

規定入力レベル -10dB (AUX RETURN VOLUME 規定位置)

最小入力レベル -16dB (AUX RETURN VOLUME MAX.)

2TR IN L,R

入力インピーダンス 10 kΩ

規定入力レベル -10dB (MONITOR/PHONES VOLUME 規定位置)

最小入力レベル -16dB

INSERT OUT 1,2

出力インピーダンス 100Ω

規定負荷インピーダンス 10 kΩ 以上

規定出力レベル -10dB (10 kΩ 負荷時)

AUX SEND 1,2

出力インピーダンス 1kΩ

規定負荷インピーダンス 10 kΩ 以上

規定出力レベル -10dB (10 kΩ 負荷時)

STEREO OUT L.R.

出力インピーダンス 1k Ω

規定負荷インピーダンス 10 kΩ 以上

規定出力レベル -10dB (10 kΩ 負荷時)

MONITOR OUT L,R

出力インピーダンス 1kΩ

規定負荷インピーダンス 10 kΩ 以上

TAPE OUT 1~8

出力インピーダンス 100 Ω

規定負荷インピーダンス 10 kΩ 以上

規定出力レベル -10dB (10 kΩ 負荷時)

規定出力レベル -10dB (10 kΩ 負荷時)

PHONES

規定負荷インピーダンス 8 ~ 40 Ω

最大出力レベル 100mW (40 Ω 負荷時)

ミキサー部

周波数特性 (規定入出力時)

20Hz ~ 20 kHz $^{+1}_{-4}$ dB

MIC IN-STEREO OUT

LINE IN-STEREO OUT

LINE IN-PHONES OUT

ノイズレベル (12.7kHz -6dB/oct. L.P.F)

入力換算ノイズ

-115dB/Rs= 150Ω

STEREO OUT

-80dB/CH,MASTER FADER 規定位置

S/N (規定入力、規定出力レベル位置)

68dB/IHF-A MIC IN-STEREO OUT (GAIN TRIM MAX.)

70dB/IHF-A LINE IN-STEREO OUT (GAIN TRIM MIN.)

歪率 (1kHz, 規定入出力時)

0.3 %/30kHz L.P.F MIC IN-STEREO OUT (GAIN TRIM MAX.)

0.05%/30kHz L.P.F LINE IN-STEREO OUT (GAIN TRIM MIN.)

イコライザー

LOW/SHELVING

基準周波数 100Hz 可変範囲 ±12dB

MID/PEAKING

基準周波数 1kHz 可変範囲 ±12dB

HIGH/SHELVING

基準周波数 10kHz 可変範囲 ±12dB

レコーダー部

(4トラック同時録音)

総合周波数特性

 $50 \text{Hz} + \frac{13}{5} \text{dB} \sim 14 \text{kHz} + \frac{13}{5} \text{dB} \text{ (dbx NR OFF)}$

総合S/N

80dB/IHF-A (dbx NR ON)、歪率3%レベル

総合歪率

2% (400Hz, -10dB レベル)

総合チャンネルセパレーション

60dB (1kHz, -10dB レベル dbx NR ON)

(隣接チャンネル間)

消去率

55dB (1kHz, 0dB レベル)

ノイズ・リダクション

dbx NR (SYNC POSITION: Tr 8=OFF)

その他

操作端子

PUNCH I/O (FC4またはFC5)

REMOTE CONTROL (RCM1)

電源

AC100V 50/60Hz

消費電力

35W

最大外形寸法

 $489(W) \times 129(H) \times 390(D)$

重量

7.0 Kg

付属品

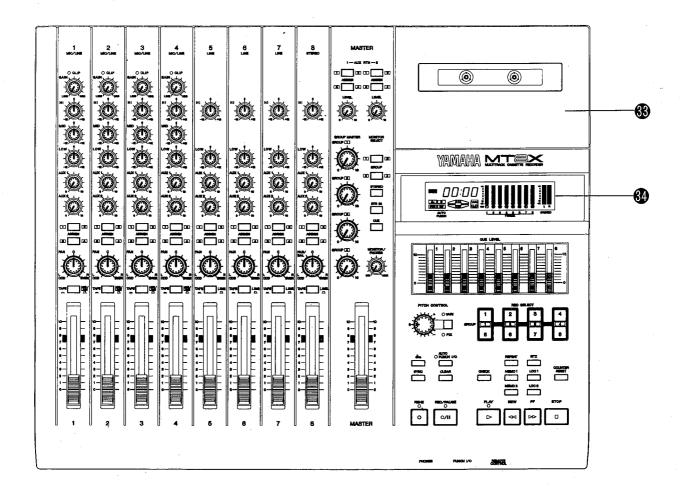
電源コード、綿棒

オプション

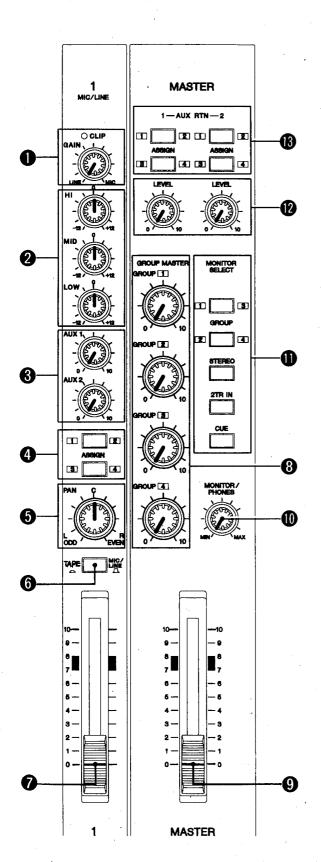
インサーションケーブル

YIC025/YIC050/YIC070

■ PANEL LAYOUT(パネルレイアウト)



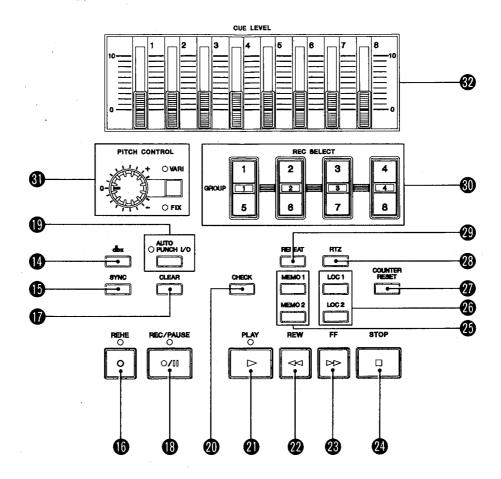
● MIXER(ミキサー部)



- GAIN Control and CLIP Indicator
- Equalizer Controls
- **6** AUX 1 and 2 Controls
- ASSIGN Switches
- PAN Control
- 6 Input Selector Switch
- **7** Channel Fader
- **3** GROUP MASTER Controls
- STEREO Fader
- **MONITOR/PHONES Control**
- **MONITOR SELECT Switches**
- **(2)** AUX RTN LEVEL Controls
- **®** AUX RTN ASSIGN Switches

- **●GAINコントロールツマミ,CLIPインジケーター**
- 2イコライザーツマミ
- ❸AUX1,2コントロールツマミ
- ASSIGNスイッチ
- ⑤PAN(パンポット)コントロールツマミ
- ⑥入力セレクトスイッチ
- ⑦チャンネルフェーダー
- **❸GROUP MASTERコントロールツマミ**
- ②ステレオフェーダー
- **MONITOR/PHONES**コントロールツマミ
- **●**MONITOR SELECTスイッチ
- **PAUX RTN LEVELコントロールツマミ**
- **⑱**AUX RTN ASSIGNスイッチ

● RECORDER(レコーダー部)

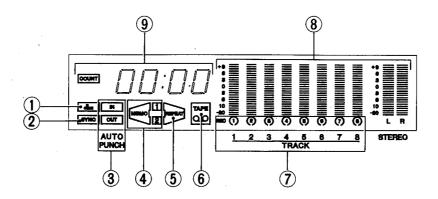


- **(b)** dbx Switch
- **(B)** SYNC Switch
- **®** REHE Button Indicator
- **©** CLEAR Button
- **®** REC/PAUSE Button and Indicator
- AUTO PUNCH I/O Button and Indicator
- **@** CHECK Button
- PLAY Button and Indicator
- REW Button
- FF Button
- STOP Button
- MEMO 1 and 2 Buttons
- LOC 1 and LOC 2 Buttons
- **@** COUNTER RESET Button
- RTZ Button
- REPEAT Button
- ® REC SELECT Switches
- **®** CUE LEVEL Controls
- Cassette Compartment

- **ゆ**dbxキー
- **⊕**SYNC+-
- **®**REHEキー,インジケーター
- **MCLEAR**+-
- ®REC/PAUSEキー,インジケーター
- **®**AUTO PUNCH I/Oキー,インジケーター
- **②CHECK**+−
- **②**PLAYキー,インジケーター
- **②REWキー**
- [®]FF+−
- 2STOP+-
- **愛**MEMO 1,2キー
- **1.2** € −
- ②RTZキー
- **②REPEATキー**
- **⊕**REC SELECT+

 −
- **動PITCH CONTROL**ツマミ,スイッチ,インジケーター
- **②CUE LEVELコントロール**
- のカセットホルダー

● DISPLAY(ディスプレイ部) 3



- 1) dbx Indicator
- **② SYNC Indicator**
- 3 Automatic Punch-in/out Indicator
- 4 MEMO 1 and 2 Indicators
- **⑤ REPEAT Indicator**
- **(6) TAPE Indicator**
- **7) REC Select Indicators**
- **® Level Meter**
- **9 Tape Counter**

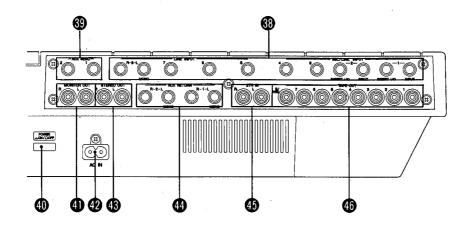
- ①dbxインジケーター
- ②SYNCインジケーター
- ③AUTO PANCH IN, OUTインジケーター
- ④MEMO 1,2インジケーター
- ⑤REPEATインジケーター
- ⑥TAPEインジケーター
- ①REC SELECTインジケーター
- ⑧レベルメーター
- ⑨テープカウンター

● FRONT PANEL (フロントパネル部)

РН	DNES	PUNCH	1/0	REMOTE CONTROL	
	35	36		37	<u> </u>

- PHONES Jack
- PUNCH I/O Jack
- **®** REMOTE CONTROL Jack
- **⊕**PHONES端子
- ⑤PUNCH I/O端子
- **REMOTE CONTROL端子**

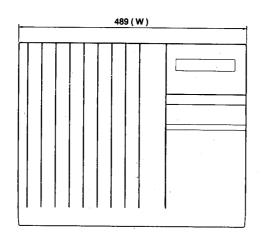
●REAR PANEL (リアパネル部)

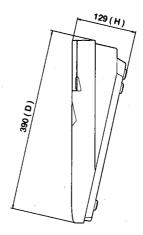


- **® MIC/LINE INPUT, LINE INPUT and INSERT I/O Jacks**
- AUX SEND 1 and 2 Jacks
- **® POWER Switch**
- **MONITOR OUT Jacks**
- AC IN Socket
- **®** STEREO OUT Jacks
- AUX RETURN 1 and 2 Jacks
- **6** 2TR IN Jacks
- TAPE OUT Jacks (1-8/SYNC)

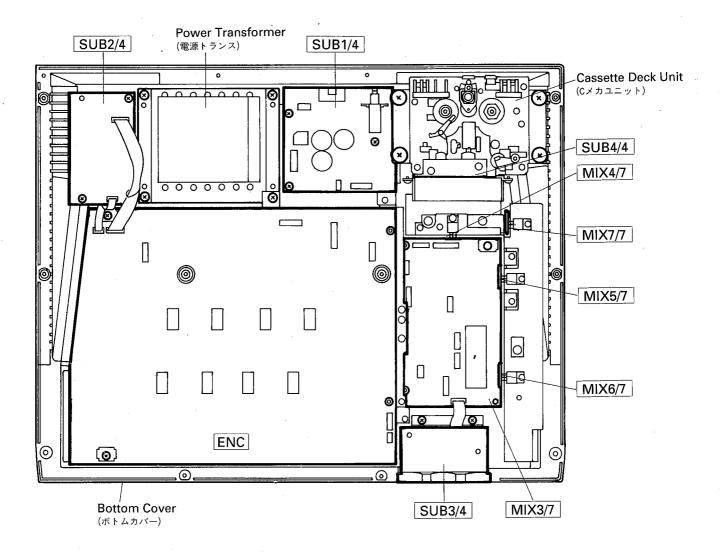
- ❸MIC/LINE INPUT LINE INPUT,INSERT I/O端子
- ❸AUX SEND 1,2端子
- POWERスイッチ
- **●**MONITOR OUT端子
- **②**AC INソケット
- ❸STEREO OUT端子
- ●AUX RETURN端子
- 492TN IN端子
- ●TAPE OUT端子(1~8/SYNC)

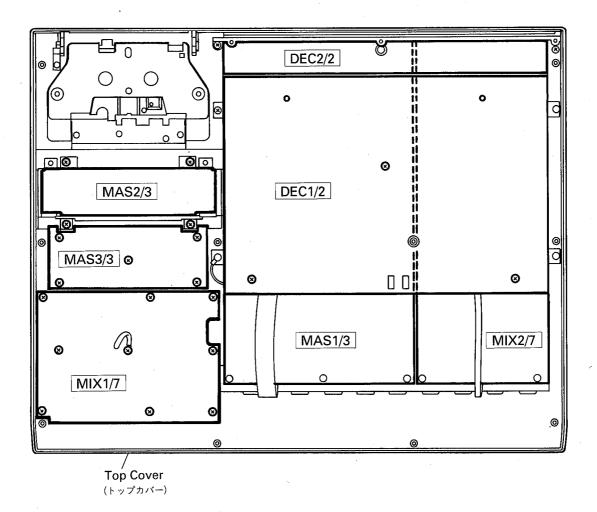
■ DIMENSIONS(寸法図)



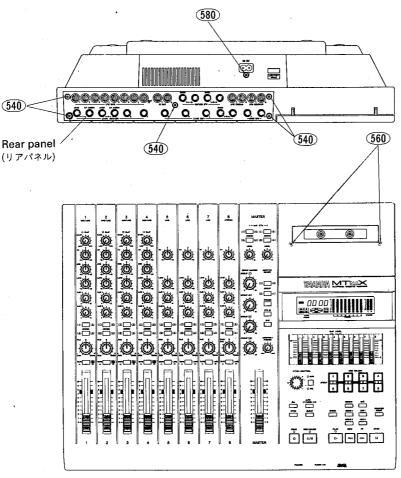


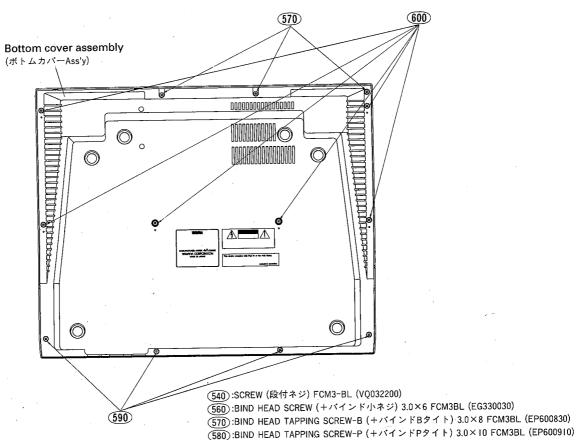
■ CIRCUIT BOARD LAYOUT (ユニットレイアウト)





■ DISASSEMBLY PROCEDURE(分解手順)





(Fig. 1)

590 :BIND HEAD TAPPING SCREW-P (+バインドPタイト) 3.0×16 FCM3BL (VD016800) 600 :BIND HEAD TAPPING SCREW-P (+パインドPタイト) 3.0×35 FCM3BL (VQ032700)

1. Bottom Cover Assembly Removal

1-1. Remove the three (3) screws marked 570, the four (4) screws marked 590, the six (6) screws marked 600 and the two (2) screws marked 560, then the bottom cover assembly can be removed. (Fig.1)

1. ボトムカバーAss'yの外し方

1-1 <u>570</u> のネジを3本、<u>590</u> のネジを4本、<u>600</u> のネジ を6本、<u>560</u> のネジ2本を外し、ボトムカバーAss'y を外します。(図1)

2. ENC Circuit Board Removal

- 2-1. Remove the bottom cover assembly. (see procedure 1)
- 2-2. Remove the two (2) plastic rivets marked (§30A) . (Fig.2)
- 2-3. Remove the two (2) screws marked 580A , then the ENC circuit board can be removed. (Fig.2)

2. ENCシートの外し方

- 2-1 ボトムカバーAss'yを外します。(1項参照)
- 2-2 ⑥30A) のプラリベット2本を外します。(図2)
- 2-3 (80A) のネジ2本を外し、ENCシートを外します。 (図2)

3. MIX-3/7 Circuit Board Removal

- 3-1. Remove the bottom cover assembly. (see procedure 1)
- 3-2. Remove the three (3) plastic rivets marked (30B) . (Fig.2)
- 3-3. Remove the screw marked (1988), then the MIX-3/7 circuit board can be removed. (Fig.2)

3. MIX-3/7シートの外し方

- 3-1 ボトムカバーAss'yを外します。(1項参照)
- 3-2 630B のプラリベット3本を外します。(図2)
- 3-3 580B のネジ1本を外し、MIX-3/7シートを外しま す。(図2)

4. SUB-1/4 Circuit Board Removal

- 4-1. Remove the bottom cover assembly. (see procedure 1)
- 4-2. Remove the screw marked 580 . (Fig.1)
- 4-3. Remove the three (3) screws marked (40), then the SUB-1/4 circuit board can be removed. (Fig.2)

4. SUB-1/4シートの外し方

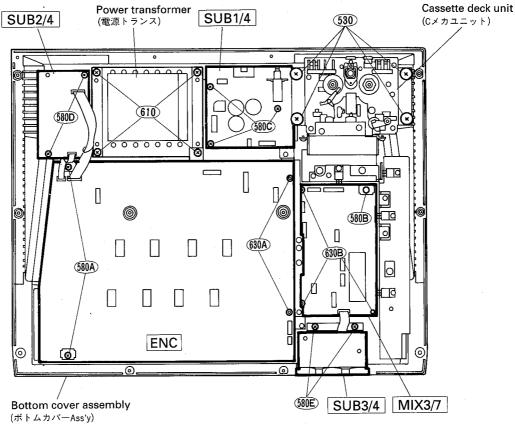
- 4-1 ボトムカバーAss'yを外します。(1項参照)
- 4-2 AC IN端子を止めている (580) のネジ1本を外しま す。(図1)
- 4-3 580C のネジ3本を外し、SUB-1/4シートを外しま す。(図2)

5. SUB-2/4 Circuit Board Removal

- 5-1. Remove the bottom cover assembly. (see procedure 1)
- 5-2. Remove the two (2) screws marked (800), then the SUB-2/4 circuit board can be removed. (Fig.2)

5. SUB-2/4シートの外し方

- 5-1 ボトムカバーAss'yを外します。(1項参照)
- 5-2 500 のネジ2本を外し、SUB-2/4シートを外しま す。(図2)



- (530):SCREW(段付ネジ) ZMC2-Y (VQ031900)
- (580) :BIND HEAD TAPPING SCREW-P (+バインドPタイト) 3.0×10 FCM3BL (EP600910)

(610):BIND HEAD TAPPING SCREW-P (+バインドPタイト) 4.0×12 FCM3BL (VB744600)

6. SUB-3/4 Circuit Board Removal

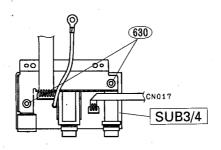
6-1. Remove the bottom cover assembly. (see procedure 1)

(Fig. 2)

- 6-2. Remove the two (2) screws marked (Fig.2)
- 6-3. Remove the two (2) plastic rivets marked (630), then the SUB-3/4 circuit board can be removed. (Fig.3)

6. SUB-3/4シートの外し方

- 6-1 ボトムカバーAss'yを外します。(1項参照)
- 6-2 (580m) のネジ2本を外します。(図2)
- 6-3 <u>630</u> のプラリベット2本を外し、SUB-3/4シートを 外します。(図3)



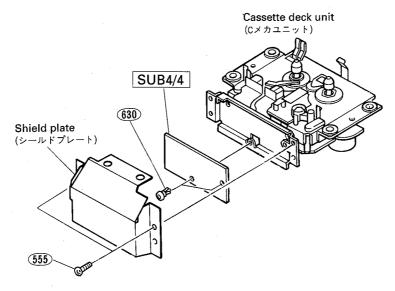
(Fig. 3)

7. SUB-4/4 Circuit Board Removal

- 7-1. Remove the bottom cover assembly. (see procedure 1)
- 7-2. Remove the four (4) screws marked 530, then the cassette deck unit can be removed. (Fig.2)
- 7-3. To remove the shield plate, remove the two (2) screws marked (555) . (Fig.4)
- 7-4. Remove the two (2) plastic rivets marked 630, then the SUB-4/4 circuit board can be removed. (Fig.4)

7. SUB-4/4シートの外し方

- 7-1 ボトムカバーAss'yを外します。(1項参照)
- 7-2 (530) のネジ4本を外し、Cメカユニットを外します。 (図2)
- 7-3 (555) のネジ2本を外し、Cメカユニットからシール ドプレートを外します。(図4)
- 7-4 **630** のプラリベット2本を外し、SUB-4/4シートを 外します。(図4)



(555):BIND HEAD TAPPING SCREW-B (+バインドBタイト) 3.0×5 ZMC2-Y (VQ030800)

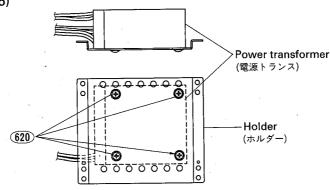
(Fig. 4)

8. Power Transformer Removal

- 8-1. Remove the bottom cover assembly. (see procedure 1)
- 8-2. Remove the four (4) screws marked (610), then the power transformer can be removed with the holder. (Fig.2)
- 8-3. To remove the holder, remove the four (4) screws marked 620 . (Fig.5)

8. 電源トランスの外し方

- 8-1 ボトムカバーAss'yを外します。(1項参照)
- 8-2 610 のネジ4本を外します。(図2)
- 8-3 <u>620</u> のネジ4本を外し、ホルダーから電源トランス を外します。(図5)

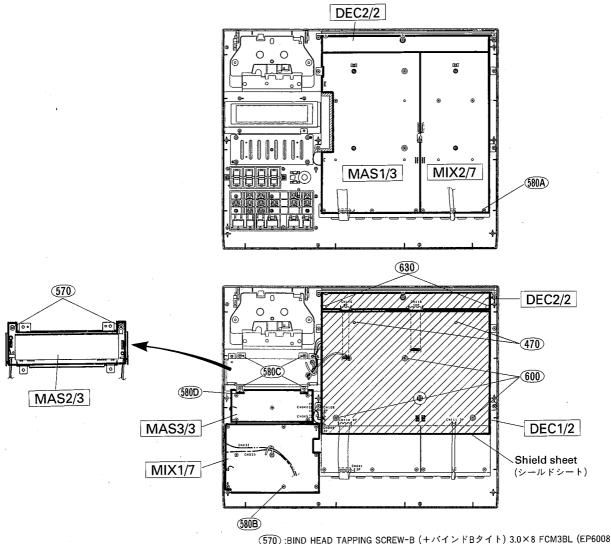


(620) :SELF TAPPING SCREW-S (カップSタイト) 4.0×8 FNM3-BL (VE460600)

9. DEC-1/2 Circuit Board Removal

- 9-1. Remove the bottom cover assembly. (see procedure 1)
- 9-2. Remove the three (3) screws marked 600 and the two (2) plastic rivets marked 630, then the shield sheet can be removed. (Fig.6)
- 9-3. Remove the DEC-1/2 circuit board from the two (2) spacers marked 470 . (Fig.6)
 - * DEC-1/2 circuit board is directly connected to the MIX-2/7 and the MAS-1/3 with the connector CN109 and CN110.

- 9. DEC-1/2シートの外し方
- 9-1 ボトムカバーAss'yを外します。(1項参照)
- 9-2 600 のネジ3本と 630 のプラリベット2本を外し、 シールドシートを外します。(図6)
- 9-3 (470) のスペーサー2ケ所を外し、DEC-1/2シートを 真上に引き抜きます。(図6)
 - 注) DEC-1/2シートは、CN109とCN110でMIX-2/7 シートとMAS-1/3シートに直接接続されてい



- (570):BIND HEAD TAPPING SCREW-B (+バインドBタイト) 3.0×8 FCM3BL (EP600830)
- 580 :BIND HEAD TAPPING SCREW-P (+バインドPタイト) 3.0×10 FCM3BL (EP600910) (Fig. 6) (600) :BIND HEAD TAPPING SCREW-P (+バインドPタイト) 3.0×35 FCM3BL (VQ032700)

DEC-2/2, MAS-1/3 and MIX-2/7 Circuit 10. **Board Removal**

- 10-1. Pull out the knobs in channel input section.
- 10-2. To remove the rear panel, remove the five (5) screws marked 540. (Fig.1)
- 10-3. Remove the bottom cover assembly. (see procedure 1)
- 10-4. Remove the DEC-1/2 circuit board. (see procedure 9)

10. DEC-2/2シート、MAS-1/3シート、MIX-2/7シートの 外し方

- 10-1 ミキサー部のツマミを全て外します。
- 10-2 (540) のネジ5本を外し、リヤパネルを外します。
- 10-3 ボトムカバーAss'yを外します。(1項参照)
- 10-4 DEC-1/2シートを外します。(9項参照)

- 10-5. Remove the seventeen (17) screws marked (Fig.6)
- 10-6. To remove the two (2) stays, remove the ten (10) hexagonal nuts marked [510]. (Fig.7)
- 10-7. Remove the seventeen (17) u-shaped holders marked 500 and the seven (7) screws marked 575, then the sub chassis can be removed. (Fig.7)
- 10-8. Disconnect CN120, then the DEC-2/2 circuit board can be removed.
- 10-9. Disconnect CN036, then the MAS-1/3 circuit board and MIX-2/7 circuit board can be removed. (Fig.7)

MIX-1/7 Circuit Board Removal

- 11-1. Pull out the pitch control knob.
- 11-2. Remove the bottom cover assembly. (see procedure 1)
- 11-3. Remove the nine (9) screws marked \$\ \emptyset{\text{80B}} \, , then the MIX-1/7 circuit board can be removed. (Fig.6)

MAS-2/3 Circuit Board Removal

- 12-1. Remove the bottom cover assembly. (see procedure 1)
- 12-2. Remove the four (4) screws marked 5800 . (Fig.6)
- 12-3. Remove the two (2) screws marked (570), then the MAS-2/3 circuit board can be removed. (Fig.6)

MAS-3/3 Circuit Board Removal

- 13-1. Pull out the cue level knobs and the spacers.
- 13-2. Remove the bottom cover assembly. (see procedure 1)
- 13-3. Remove the five (5) screws marked (800), then the MAS-3/3 circuit board can be removed. (Fig.6)

- 10-5 580A のネジ17本を外します。(図6)
- 10-6 (510) の特殊六角ナット10ケを外し、ステー2本を外 します。(図7)
- 10-7 500 のU字金具17ケと 575 のネジ7本を外し、サ ブシャーシを外します。(図7)
- 10-8 DEC-2/2シートのCN120をMAS-1/3シートから 引き抜き、DEC-2/2シートを外します。
- 10-9 MIX-2/7シートのCN036を外すと、MAS-1/3シー トとMIX-2/7シートが外れます。(図7)

11. MIX-1/7シートの外し方

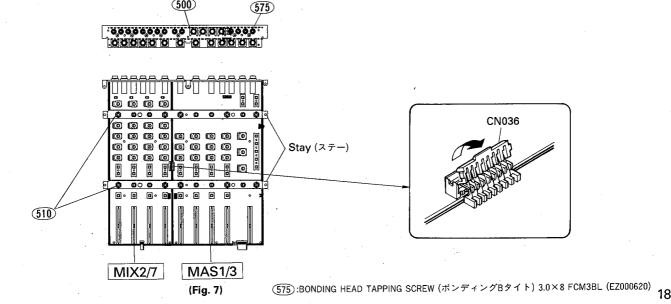
- 11-1 PITCH CONTROLのツマミを外します。
- 11-2 ボトムカバーAss'yを外します。(1項参照)
- 11-3 (580B) のネジ9本を外し、MIX-1/7シートを外しま す。(図6)

12. MAS-2/3シートの外し方

- 12-1 ボトムカバーAss'yを外します。(1項参照)
- 12-2 5800 のネジ4本を外します。(図6)
- 12-3 (570) のネジ2本を外し、ステーからMAS-2/3シー トを外します。(図6)

13. MAS-3/3シートの外し方

- 13-1 CUE LEVELのツマミとスペーサーを外します。
- 13-2 ボトムカバーAss'yを外します。(1項参照).
- 13-3 (580D) のネジ5本を外し、MAS-3/3シートを外しま す。(図6)



■LSI PIN DESCRIPTION (LSI端子機能表)

• M38022M2SP (XM267A00) CPU

PIN NO.	NAME	1/0	FUNCTION	PIN NO.	NAME	1/0	FUNCTION
1	vcc	1		41	sw	ı	Punch I/O "L": Unpluged, "H": pluged
2	VR	- 1		42	-		Not use
3	AVSS	- 1		43	FF	0	
4	1, 2	- 1	A/D Track 1, 2	44	PLAY	0	Reel motor speed control
5	3, 4	ı	A/D Track 3, 4				Pin PLAY FF igh FF
6	5, 6	ı	A/D Track 5, 6 Level meter data				43,FF "H" "L" "L"
7	7,8	ļ	A/D Track 7, 8 *1				44,PLAY "L" "H" "L"
8	L, R	!	A/D Stereo out L, R				
9	Key 1	!	A/D Key 1				
10	Key 2	!	A/D Key 2 Operation key data	4-	DNAD		
11	Key 3 PLAY		A/D Key 3 J LED (Play)	45 46	RMR	0	Reel motor direction control
12 13	REC	0	LED /Pas/Pausa)	46	RMF	0	
14	RH	ŏ	LED (Rec/Fause)		'		Direction
15	P, I/O	ő	LED (Auto punch I/O) *2				PIN FF REW
16	CTR	ŏ	A/D Select "L":Meter CH1, 3, 5, key B, D				45, RMR "L" "H"
'0	0111	J	"H":Meter CH2, 4, 6, 8, key A, C				46, RMF "H" "L"
17	CL	I/O	Chip Select (to M66008)				
18	CLK	ő	Clock (to M66008)	47	AM -	О	1
19	DATA	ŏ	Data (to M66008)	48	AM +	ŏ	Assist motor control
20	CLK	ō	Clock (to MSC1164)	49	1/0	Ī	Condition of foot switch "L": off, "H": on
21	DIN	0	Din (to MSC 1164)	50	P.DET	l i	Delection of power Off
22	LS	0	Latch strove (to MSC1164)	51	SW2	- 1) Detection of cassetle mechanical
23	CL	0	Clear (to MSC1164)	52	SW1	1	unit position
24	_		Not use	53	REC	- 1	"L": Recording possible, "H": Recording
25	SYNC	О	Analog switch control "L": SYNC on				impossible
26	CNVSS	! !	Ground	54	HS	ı	"L": Tape eguipped, "H": Tape not
27	RESET	Ĭ	Reset				eguipped
28	DBX	0	dBx "L": on, "H": off	55	RPT	!	Detection of reel pulse
29	CUE X1	o	Not use	56	RPS	ı	PRT: Take up side
30	XO	0	Clock	57	PB. MUTE1	0	RPS: Supply side
32	vss	U	Ground	58	PB. MUTE2	Ö	
		0)				
			Recording mute control				Play back mute control
							"L": Other than play back condition
							"H": In recording condition
		ŏ)	63			
	BIAS2	ŏ	Bias oscillating control	64		ŏ	
39	BIAS3	ŏ	"L": Other than recording condition			_	,
40	BIAS4	ŏ	"H": Recording condition				
33 34 35 36 37 38 39	R. MUTE1 R. MUTE2 R. MUTE3 R. MUTE4 BIAS1 BIAS2 BIAS3	0	Recording mute control "L": Other than recording condition "H": Recording condition Bias oscillating control "L": Other than recording condition	59 60 61 62 63	PB. MUTE3 PB. MUTE4 PB. MUTE5 PB. MUTE6 PB. MUTE7 PB. MUTE8	00000	

*1 A/D DATA (METER)

Segment	20	-10	6	-3	0	+3	+6	+10
Voltage [V]	0.353	0.598	0.753	0.859	1.00	1.164	1.353	1.568

*2 A/D DATA (KEY)

	Α	4	8	RESET	STOP	FF	REW	_	_
KEÝ	В	3	7	RTZ	LOC2	MONO2	PLAY	-	-
NE Y	С	2	6	LOC1	MONO1	CLEAR	SYNC	REC/PAUSE	_
	D	1	5	REPEAT	CHECK	AUTO I/O	dbx	REHE	-
Voltage	[V]	0.0	0.69	1.43	2.21	2.87	3.63	4.31	5.0

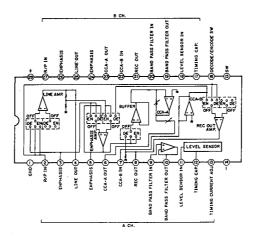
• M66008P (XM266A00) EXP. I/O

PIN NO.	NAME	I/O	FUNCTION	PIN NO.	NAME	I/O	FUNCTION
1	DO	_	Not used	13	D12	0	Encode/Decode (CH4)
2	DI	- 1	Data	14	D11	0	Encode/Decode (CH3) "L": Recording signa
3	<u>CLK</u>	- 1	Clock	15	D10	0	Encode/Decode (CH2) "H": play back signal
4	CS	- 1	Chip select	16	D 9	0	Encode/Decode (CH1)
5	VCC		Power supply	17	D 8	0 .	Monitor select (CH8)
6	ร	- 1	Set in	18	D 7	0	Monitor select (CH7) Whether to return
7	GND		Ground	19	D 6	0	Monitor select (CH6) played back sound to
8	D16	0	Encode/Decode (CH8)	20	D 5	0	Monitor select (CH5) mixer input
9	D15	0	Encode/Decode (CH7) "L": Recording signal	21	D 4	0	Monitor select (CH4) "L" Level:Not to be returned (being
10	D14	0	Encode/Decode (CH6) TH": play back signal	22	D 3	0	Monitor select (CH3) recorded)"H" Level:To
11	D13	0	Encode/Decode (CH5)	23	D 2	0	Monitor select (CH2) be returned (being
12	GND		Ground	24	D 1	0.	Monitor select (CH1) played back)

• MSC1164 (XM255A00) FL DRIVER

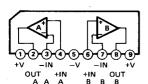
PIN NO.	NAME	I/O	FUNCTION	PIN NO.	NAME	1/0	FUNCTION
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16	- DO LS CL +5	0 000000000	Data output Latch strove Clear Power supply Driver	17 18 19 20 21 22 23 24 25 26 27 28 29 30 31	+32 GND CLK DI - -	0000000000	Power supply (Driver) Ground Clock Data input

• AN6292NK (XJ637A00) Dual dbx NR



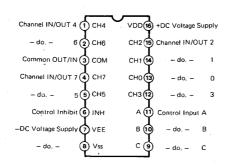
■IC BLOCK DIAGRAM (ICブロック図)

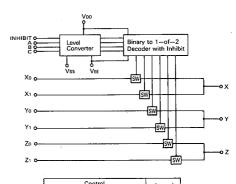
- NJM2068S-D (XE322A00)
- NJM4558S (IG076800)
- NJM4560S (IG121800)
- μ**PC4570HA** (XB247A00) Dual Operational Amplifier



• **BU4053B** (IG149000)

Triple 2-Ch.
Multiplexer/Demuliplexer

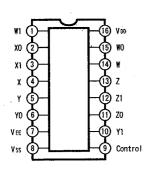


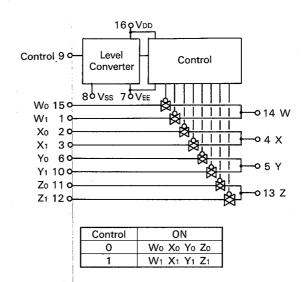


channel		Control							
"ON"	A	В	C	INHIBIT					
Zo, Yo, Xo	L	L	L	L					
Zo, Yo, X1	н	L	L	L					
Zo, Y1, Xo	L	Н.	L	L					
Zo, Y1, X1	Н	Н	L	· L					
Z1, Yo, Xo	L	L	Н	L					
Z1, Y0, X1	Н	L	Н	L					
Z1, Y1, X0	L	н	Η:	L					
Z1, Y1, X1	Н	н	н	L'					
NONE	X	X	×	н					

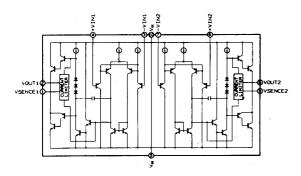
• BU4551B (XI929A00)

Quad 2 Channel Analog Multuiplexer/Demultiplexer

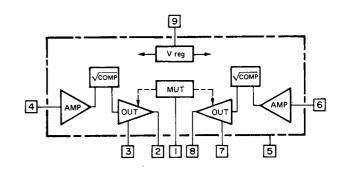




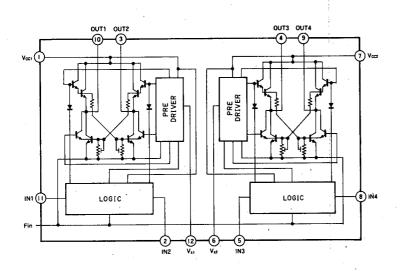
LA6515 (XI250A00)
 Operational Amplifier



• BA6138 (IG074900) (1/2W Power of Compressor Amp.)



LB1649 (XA299A00)
 Motor Driver



• LC4966 (IG149300) Quad Analog Switch

